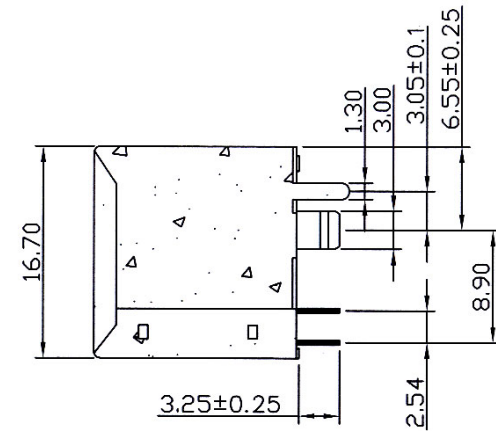
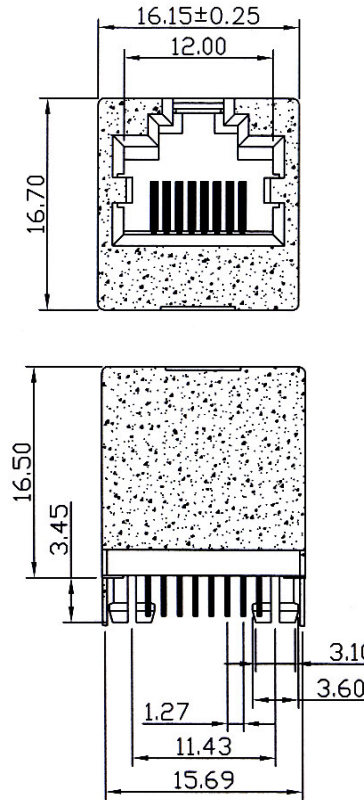


PC Board Layout

SPECIFICATIONS

- Contact material: Phosphor bronze 0.35mm
- Contact plating: Gold 6, 15, 30, 50 μ in contact area
Gold Flash in solder area
- Housing material: PBT Polyester glass fiber, UL94V-0
- Shield material: Copper alloy 0.25mm
- Shield plating: Nickel



| Series | Positions | Contacts | Body | Ground Tab | Color | Plating | Options |
|--------------------|---------------|---------------|--------------------------|-----------------|----------|--|--|
| CTJ | 8 | 08 | DS | C1 | BK | P1 | XX |
| Modular phone jack | 8=8 positions | 08=8 contacts | DS=Top Entry Stamped Pin | C1=3.05mm Front | BK=Black | P1=15 μ " gold P2=30 μ " gold P3=50 μ " gold | FS=Full shield WF=Without flange KY=With key way |

RoHS compliant

| Rev. | Description | Date | Approved | Drawing | Name | Date |
|------|-------------|------|----------|------------|-------------|-------------|
| | | | | Approved | Howard | 08/10/99 |
| | | | | Checked | Lizzy | 08/10/99 |
| | | | | Drawn | Tina | 08/10/99 |
| | | | | 0.0 ± 0.35 | 0.00 ± 0.20 | Angles ± 3° |
| | | | | UNIT: mm | | |

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Part No.: **CTJ-8-08-DS-C1-BK-XX-FS-WF**

Description: Modular jack, 8P8C, shielded, top entry, Full Peg